TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

# 2SK3313

# Chopper Regulator, DC-DC Converter Applications Motor Drive Applications

• Fast reverse recovery time  $: t_{rr} = 90 \text{ ns (typ.)}$ 

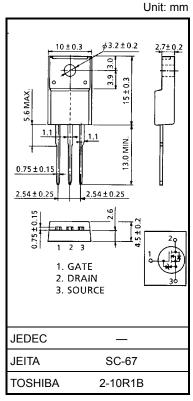
• Built-in high-speed free-wheeling diode

 $\begin{array}{ll} \bullet & \text{Low drain-source ON resistance} & : R_{DS \; (ON)} = 0.5 \; \Omega \; (\text{typ.}) \\ \bullet & \text{High forward transfer admittance} & : |Y_{fs}| = 8.5 \; S \; (\text{typ.}) \\ \bullet & \text{Low leakage current} & : I_{DSS} = 100 \; \mu\text{A} \; (\text{max}) \; (\text{V}_{DS} = 500 \; \text{V}) \\ \end{array}$ 

• Enhancement-mode :  $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$ 

#### Maximum Ratings (Ta = 25°C)

Characteris	stics	Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	500	V
Drain-gate voltage (R	<sub>SS</sub> = 20 kΩ)	$V_{DGR}$	500	V
Gate-source voltage		$V_{GSS}$	±30	V
Drain current	DC (Note 1)	I <sub>D</sub>	12	Α
Dialii cuirent	Pulse (Note 1)	$I_{DP}$	48	Α
Drain power dissipation	n (Tc = 25°C)	$P_{D}$	40	W
Single pulse avalanche	e energy (Note 2)	E <sub>AS</sub>	324	mJ
Avalanche current		I <sub>AR</sub>	12	Α
Repetitive avalanche e	nergy (Note 3)	E <sub>AR</sub>	4.0	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature ra	ange	T <sub>stg</sub>	-55~150	°C



Weight: 1.9 g (typ.)

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	3.125	°C/W
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	62.5	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:  $V_{DD}$  = 90 V,  $T_{ch}$  = 25°C (initial), L = 3.83 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = 12 A

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.



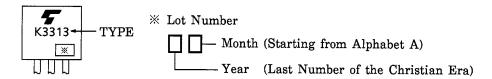
# **Electrical Characteristics (Ta = 25°C)**

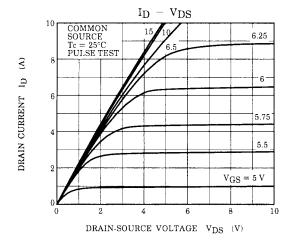
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±25 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V (BR) GSS	I <sub>G</sub> = ±100 μA, V <sub>DS</sub> = 0 V	±30	_	_	V
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = 500 V, V <sub>GS</sub> = 0 V	_	_	100	μΑ
Drain-source br	eakdown voltage	V (BR) DSS	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	500	_	_	V
Gate threshold v	oltage	V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	2.0	_	4.0	V
Drain-source O	N resistance	R <sub>DS (ON)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A	_	0.5	0.62	Ω
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6 A	3.0	8.5	_	S
Input capacitano	e	C <sub>iss</sub>		_	2040	_	
Reverse transfe	r capacitance	C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	_	210	_	pF
Output capacitance		Coss		_	630	_	]
Switching time	Rise time	tr	$V_{\rm GS}$ $10V$ $I_{\rm D}=6A$ $V_{\rm OUT}$ $R_{\rm L}$ $=33\Omega$ $V_{\rm DD}=200V$ Duty $\leq 1\%$ , $t_{\rm W}=10\mu{\rm s}$	_	22	_	
	Turn-on time	t <sub>on</sub>		1	58		20
	Fall time	t <sub>f</sub>		ı	36	l	ns
	Turn-off time	t <sub>off</sub>		-	180	_	
Total gate charge (Gate-source plus gate-drain)		Qg	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$		45		
Gate-source charge		Q <sub>gs</sub>			25	_	nC
Gate-drain ("miller") charge		$Q_{gd}$			20	_	

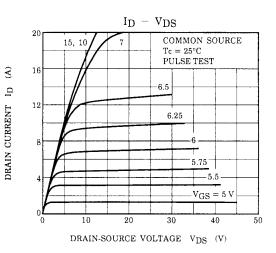
# Source-Drain Ratings and Characteristics (Ta = 25°C)

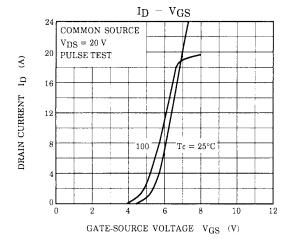
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	_	_	_	12	Α
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	_	_	_	48	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 12 A, V <sub>GS</sub> = 0 V	_	_	-1.7	V
Reverse recovery time	t <sub>rr</sub>	I <sub>DR</sub> = 12 A, V <sub>GS</sub> = 0 V	1	90	160	ns
Reverse recovery charge	Q <sub>rr</sub>	dl <sub>DR</sub> / dt = 100 Å / μs	1	0.25	1	μC

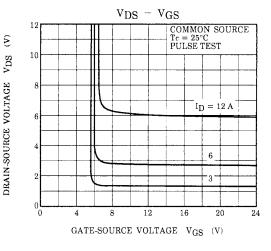
# Marking

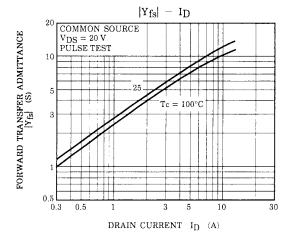


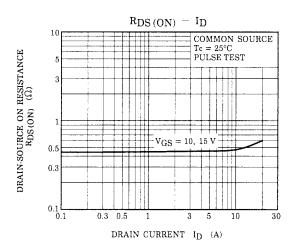


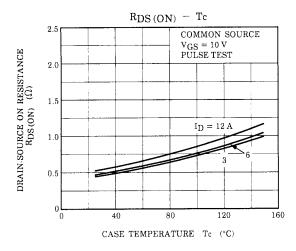


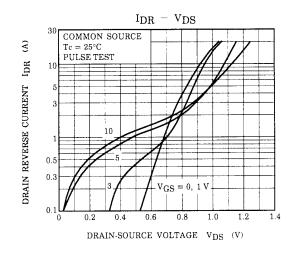


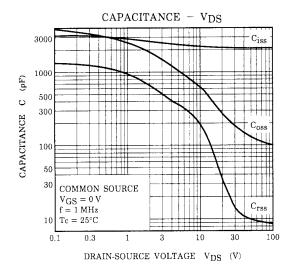


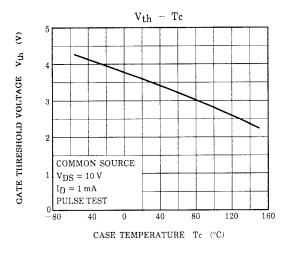


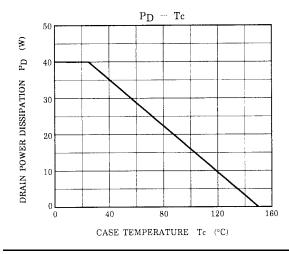


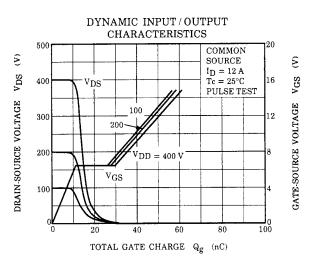


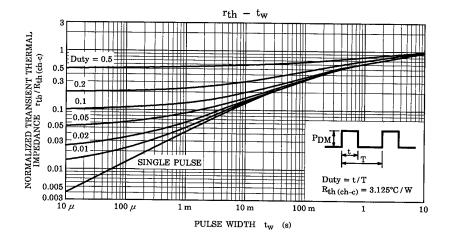


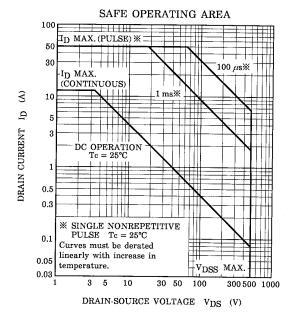


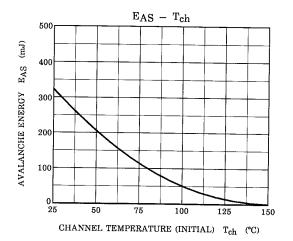


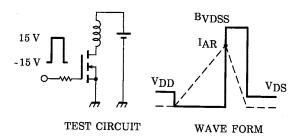












$$\begin{aligned} R_G &= 25~\Omega \\ V_{DD} &= 90~V,~L = 3.83~mH \end{aligned} \quad E_{AS} &= \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - VDD} \right) \end{aligned}$$

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